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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	3.6K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf27k40t-i-ss

PIC18(L)F2x/4xK40 Family Types

Device	Data Sheet Index	Program Memory Flash (bytes)	Data SRAM (bytes)	Data EEPROM (bytes)	I/O Pins	16-bit Timers	Comparators	10-bit ADC^2 with Computation (ch)	5-bit DAC	Zero-Cross Detect	CCP/10-bit PWM	CWG	8-bit TMR with HLT	Windowed Watchdog Timer	CRC with Memory Scan	EUSART	I^{2}C/SPI	PPS	Peripheral Module Disable	Temperature Indicator	Debug(1)
PIC18(L)F24K40	**(1)**	16k	1024	256	25	4	2	24	1	1	2/2	1	3	Y	Y	1	1	Y	Y	Y	I
PIC18(L)F25K40	**(1)**	32k	2048	256	25	4	2	24	1	1	2/2	1	3	Y	Y	1	1	Y	Y	Y	I
PIC18(L)F26K40	**(2)**	64k	3728	1024	25	4	2	24	1	1	2/2	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F27K40	**(3)**	128k	3728	1024	25	4	2	24	1	1	2/2	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F45K40	**(2)**	32k	2048	256	36	4	2	35	1	1	2/2	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F46K40	**(2)**	64k	3728	1024	36	4	2	35	1	1	2/2	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F47K40	**(3)**	128k	3728	1024	36	4	2	35	1	1	2/2	1	3	Y	Y	2	2	Y	Y	Y	I

Note 1: Debugging Methods: (I) – Integrated on Chip.

Data Sheet Index: (Unshaded devices are described in this document.)

1. DS40001843 PIC18(L)F24/25K40 Data Sheet, 28-Pin, 8-bit Flash Microcontrollers
2. DS40001816 PIC18(L)F26/45/46K40 Data Sheet, 28/40/44-Pin, 8-bit Flash Microcontrollers
3. DS40001844 PIC18(L)F27/47K40 Data Sheet, 28/40/44-Pin, 8-bit Flash Microcontrollers

Note: For other small form-factor package availability and marking information, please visit **http://www.microchip.com/packaging** or contact your local sales office.

1.2 Other Special Features

- **Memory Endurance:** The Flash cells for both program memory and data EEPROM are rated to last for many thousands of erase/write cycles – up to 10K for program memory and 100K for EEPROM. Data retention without refresh is conservatively estimated to be greater than 40 years.
- **Self-programmability:** These devices can write to their own program memory spaces under internal software control. By using a boot loader routine located in the protected Boot Block at the top of program memory, it becomes possible to create an application that can update itself in the field.
- **Extended Instruction Set:** The PIC18(L)F2x/4xK40 family introduces an optional extension to the PIC18 instruction set, which adds eight new instructions and an Indexed Addressing mode. This extension, enabled as a device configuration option, has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.
- **Enhanced Peripheral Pin Select:** The Peripheral Pin Select (PPS) module connects peripheral inputs and outputs to the device I/O pins. Only digital signals are included in the selections. All analog inputs and outputs remain fixed to their assigned pins.
- **Enhanced Addressable EUSART:** This serial communication module is capable of standard RS-232 operation and provides support for the LIN bus protocol. Other enhancements include automatic baud rate detection and a 16-bit Baud Rate Generator for improved resolution. When the microcontroller is using the internal oscillator block, the EUSART provides stable operation for applications that talk to the outside world without using an external crystal (or its accompanying power requirement).
- **10-bit A/D Converter with Computation:** This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reduce code overhead. It has a new module called ADC^2 with computation features, which provides a digital filter and threshold interrupt functions.
- **Windowed Watchdog Timer (WWDT):**
  - Timer monitoring of overflow and underflow events
  - Variable prescaler selection
  - Variable window size selection
  - All sources configurable in hardware or software

1.3 Details on Individual Family Members

Devices in the PIC18(L)F2x/4xK40 family are available in 28-pin and 40/44-pin packages. The block diagram for this device is shown in Figure 1-1.

The devices have the following differences:

1. Program Flash Memory
2. Data Memory SRAM
3. Data Memory EEPROM
4. A/D channels
5. I/O ports
6. Enhanced USART
7. Input Voltage Range/Power Consumption

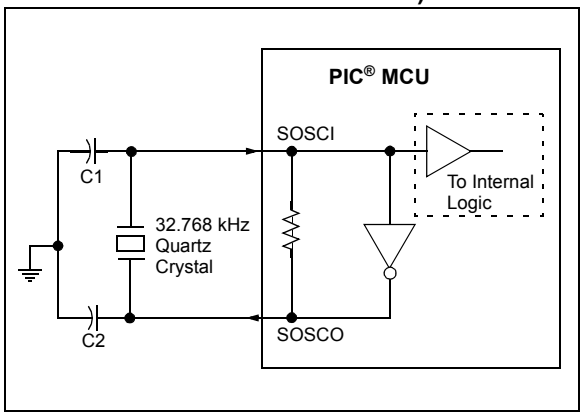
All other features for devices in this family are identical. These are summarized in Table 1-1.

The pinouts for all devices are listed in the pin summary tables (Table 1 and Table 2).

4.3.1.5 Secondary Oscillator

The secondary oscillator is a separate oscillator block that can be used as an alternate system clock source. The secondary oscillator is optimized for 32.768 kHz, and can be used with an external crystal oscillator connected to the SOSCI and SOSCO device pins, or an external clock source connected to the SOSCIN pin. The secondary oscillator can be selected during run-time using clock switching. Refer to **Section 4.4 "Clock Switching"** for more information.

FIGURE 4-5: QUARTZ CRYSTAL OPERATION (SECONDARY OSCILLATOR)



Note 1: Quartz crystal characteristics vary according to type, package and manufacturer. The user should consult the manufacturer data sheets for specifications and recommended application.

2: Always verify oscillator performance over the V_{DD} and temperature range that is expected for the application.

3: For oscillator design assistance, reference the following Microchip Application Notes:

- AN826, "*Crystal Oscillator Basics and Crystal Selection for PIC® and PIC® Devices*" (DS00826)
- AN849, "*Basic PIC® Oscillator Design*" (DS00849)
- AN943, "*Practical PIC® Oscillator Analysis and Design*" (DS00943)
- AN949, "*Making Your Oscillator Work*" (DS00949)
- TB097, "*Interfacing a Micro Crystal MS1V-T1K 32.768 kHz Tuning Fork Crystal to a PIC16F690/SS*" (DS91097)
- AN1288, "*Design Practices for Low-Power External Oscillators*" (DS01288)

4.3.2 INTERNAL CLOCK SOURCES

The device may be configured to use the internal oscillator block as the system clock by performing one of the following actions:

- Program the RSTOSC<2:0> bits in Configuration Words to select the INTOSC clock source, which will be used as the default system clock upon a device Reset.
- Write the NOSC<2:0> bits in the OSCCON1 register to switch the system clock source to the internal oscillator during run-time. See **Section 4.4 "Clock Switching"** for more information.

In INTOSC mode, OSC1/CLKIN is available for general purpose I/O. OSC2/CLKOUT is available for general purpose I/O or CLKOUT.

The function of the OSC2/CLKOUT pin is determined by the $\overline{\text{CLKOUTEN}}$ bit in Configuration Words.

The internal oscillator block has two independent oscillators that can produce two internal system clock sources.

1. The **HFINTOSC** (High-Frequency Internal Oscillator) is factory-calibrated and operates from 1 to 64 MHz. The frequency of HFINTOSC can be selected through the OSCFRQ Frequency Selection register, and fine-tuning can be done via the OSCTUNE register.
2. The **LFINTOSC** (Low-Frequency Internal Oscillator) is factory-calibrated and operates at 31 kHz.

4.3.2.1 HFINTOSC

The High-Frequency Internal Oscillator (HFINTOSC) is a precision digitally-controlled internal clock source that produces a stable clock up to 64 MHz. The HFINTOSC can be enabled through one of the following methods:

- Programming the RSTOSC<2:0> bits in Configuration Word 1 to '110' (FOSC = 1 MHz) or '000' (FOSC = 64 MHz) to set the oscillator upon device Power-up or Reset.
- Write to the NOSC<2:0> bits of the OSCCON1 register during run-time. See **Section 4.4 "Clock Switching"** for more information.

The HFINTOSC frequency can be selected by setting the HFFRQ<3:0> bits of the OSCFRQ register.

The NDIV<3:0> bits of the OSCCON1 register allow for division of the HFINTOSC output from a range between 1:1 and 1:512.

4.3.2.2 MFINTOSC

The module provides two (500 kHz and 31.25 kHz) constant clock outputs. These clocks are digital divisors of the HFINTOSC clock. Dynamic divider logic is used to provide constant MFINTOSC clock rates for all settings of HFINTOSC.

The MFINTOSC cannot be used to drive the system but it is used to clock certain modules such as the Timers and WWDT.

4.3.2.3 Internal Oscillator Frequency Adjustment

The internal oscillator is factory-calibrated. This internal oscillator can be adjusted in software by writing to the OSCTUNE register (Register 4-3).

The default value of the OSCTUNE register is 00h. The value is a 6-bit two's complement number. A value of 1Fh will provide an adjustment to the maximum frequency. A value of 20h will provide an adjustment to the minimum frequency.

When the OSCTUNE register is modified, the oscillator frequency will begin shifting to the new frequency. Code execution continues during this shift. There is no indication that the shift has occurred.

OSCTUNE **does not affect** the LFINTOSC frequency. Operation of features that depend on the LFINTOSC clock source frequency, such as the Power-up Timer (PWRT), WWDT, Fail-Safe Clock Monitor (FSCM) and peripherals, are *not* affected by the change in frequency.

4.3.2.4 LFINTOSC

The Low-Frequency Internal Oscillator (LFINTOSC) is a factory-calibrated 31 kHz internal clock source.

The LFINTOSC is the frequency for the Power-up Timer (PWRT), Windowed Watchdog Timer (WWDT) and Fail-Safe Clock Monitor (FSCM).

The LFINTOSC is enabled through one of the following methods:

- Programming the RSTOSC<2:0> bits of Configuration Word 1 to enable LFINTOSC.
- Write to the NOSC<2:0> bits of the OSCCON1 register during run-time. See **Section 4.4, Clock Switching** for more information.

4.3.2.5 ADCRC

The ADCRC is an oscillator dedicated to the ADC^2 module. The ADCRC oscillator can be manually enabled using the ADOEN bit of the OSCEN register. The ADCRC runs at a fixed frequency of 600 kHz. ADCRC is automatically enabled if it is selected as the clock source for the ADC^2 module.

REGISTER 15-3: LATx: LATx REGISTER(1)

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LATx7	LATx6	LATx5	LATx4	LATx3	LATx2	LATx1	LATx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **LATx<7:0>:** Rx7:Rx0 Output Latch Value bits

Note 1: Writes to LATx are equivalent with writes to the corresponding PORTx register. Reads from LATx register return register values, not I/O pin values.

TABLE 15-4: LAT REGISTERS

Name	Device		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	28 Pins	40/44 Pins								
LATA	X	X	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0
LATB	X	X	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0
LATC	X	X	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0
LATD	X		—	—	—	—	—	—	—	—
		X	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0
LATE	X		—	—	—	—	—	—	—	—
		X	—	—	—	—	—	LATE2	LATE1	LATE0

REGISTER 15-6: ODCONx: OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCx7	ODCx6	ODCx5	ODCx4	ODCx3	ODCx2	ODCx1	ODCx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **ODCx<7:0>**: Open-Drain Configuration on Pins Rx<7:0>

1 = Output drives only low-going signals (sink current only)

0 = Output drives both high-going and low-going signals (source and sink current)

TABLE 15-7: OPEN-DRAIN CONTROL REGISTERS

Name	Device		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	28 Pins	40/44 Pins								
ODCONA	X	X	ODCA7	ODCA6	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0
ODCONB	X	X	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0
ODCONC	X	X	ODCC7	ODCC6	ODCC5	ODCC4	ODCC3	ODCC2	ODCC1	ODCC0
ODCOND	X		—	—	—	—	—	—	—	—
		X	ODCD7	ODCD6	ODCD5	ODCD4	ODCD3	ODCD2	ODCD1	ODCD0
ODCONE	X		—	—	—	—	—	—	—	—
		X	—	—	—	—	—	ODCE2	ODCE1	ODCE0

REGISTER 21-5: CCPRxH: CCPx REGISTER HIGH BYTE

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
CCPRx<15:8>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0

MODE = Capture Mode:
CCPRxH<7:0>: MSB of captured TMR1 value
MODE = Compare Mode:
CCPRxH<7:0>: MSB compared to TMR1 value
MODE = PWM Mode && FMT = 0:
CCPRxH<7:2>: Not used
CCPRxH<1:0>: CCPW<9:8> – Pulse-Width MS 2 bits
MODE = PWM Mode && FMT = 1:
CCPRxH<7:0>: CCPW<9:2> – Pulse-Width MS 8 bits

REGISTER 24-6: CWG1AS0: CWG AUTO-SHUTDOWN CONTROL REGISTER 0

R/W/HS/HC-0/0	R/W-0/0	R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1	U-0	U-0
SHUTDOWN	REN	LSBD<1:0>		LSAC<1:0>		—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS/HC = Bit is set/cleared by hardware
q = Value depends on condition		

bit 7 **SHUTDOWN:** Auto-Shutdown Event Status bit(1,2)
- 1 = An auto-shutdown state is in effect
- 0 = No auto-shutdown event has occurred

bit 6 **REN:** Auto-Restart Enable bit
- 1 = Auto-restart is enabled
- 0 = Auto-restart is disabled

bit 5-4 **LSBD<1:0>:** CWG1B and CWG1D Auto-Shutdown State Control bits
- 11 = A logic '1' is placed on CWG1B/D when an auto-shutdown event occurs.
- 10 = A logic '0' is placed on CWG1B/D when an auto-shutdown event occurs.
- 01 = Pin is tri-stated on CWG1B/D when an auto-shutdown event occurs.
- 00 = The inactive state of the pin, including polarity, is placed on CWG1B/D after the required dead-band interval when an auto-shutdown event occurs.

bit 3-2 **LSAC<1:0>:** CWG1A and CWG1C Auto-Shutdown State Control bits
- 11 = A logic '1' is placed on CWG1A/C when an auto-shutdown event occurs.
- 10 = A logic '0' is placed on CWG1A/C when an auto-shutdown event occurs.
- 01 = Pin is tri-stated on CWG1A/C when an auto-shutdown event occurs.
- 00 = The inactive state of the pin, including polarity, is placed on CWG1A/C after the required dead-band interval when an auto-shutdown event occurs.

bit 1-0 **Unimplemented:** Read as '0'

Note 1: This bit may be written while EN = 0 (Register 24-1), to place the outputs into the shutdown configuration.

2: The outputs will remain in auto-shutdown state until the next rising edge of the CWG data input after this bit is cleared.

REGISTER 24-8: CWG1DBR: CWG RISING DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	DBR<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **DBR<5:0>:** CWG Rising Edge Triggered Dead-Band Count bits

```
11 1111 =  63-64 CWG clock periods
11 1110 =  62-63 CWG clock periods
.
.
.
00 0010 =  2-3 CWG clock periods
00 0001 =  1-2 CWG clock periods
00 0000 =  0 CWG clock periods. Dead-band generation is bypassed
```

REGISTER 24-9: CWG1DBF: CWG FALLING DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	DBF<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **DBF<5:0>:** CWG Falling Edge Triggered Dead-Band Count bits

```
11 1111 =  63-64 CWG clock periods
11 1110 =  62-63 CWG clock periods
.
.
.
00 0010 =  2-3 CWG clock periods
00 0001 =  1-2 CWG clock periods
00 0000 =  0 CWG clock periods. Dead-band generation is bypassed.
```

REGISTER 26-6: SSPxSTAT: MSSPx STATUS REGISTER (I²C MASTER MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/$\overline{A}$	P(1)	S(1)	R/$\overline{W}$(2,3)	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SMP:** Slew Rate Control bit

In Master or Slave mode:
1 = Slew rate control is disabled for Standard Speed mode (100 kHz and 1 MHz)
0 = Slew rate control is enabled for High-Speed mode (400 kHz)

bit 6 **CKE:** SMBus Select bit

In Master or Slave mode:
1 = Enables SMBus-specific inputs
0 = Disables SMBus-specific inputs

bit 5 **D/$\overline{A}$:** Data/$\overline{\text{Address}}$ bit

In Master mode:
Reserved.

In Slave mode:
1 = Indicates that the last byte received or transmitted was data
0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit(1)

1 = Indicates that a Stop bit has been detected last
0 = Stop bit was not detected last

bit 3 **S:** Start bit(1)

1 = Indicates that a Start bit has been detected last
0 = Start bit was not detected last

bit 2 **R/$\overline{W}$:** Read/$\overline{\text{Write}}$ Information bit(2,3)

In Slave mode:
1 = Read
0 = Write

In Master mode:
1 = Transmit is in progress
0 = Transmit is not in progress

bit 1 **UA:** Update Address bit (10-Bit Slave mode only)

1 = Indicates that the user needs to update the address in the SSPxADD register
0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit

In Transmit mode:
1 = SSPxBUF is full
0 = SSPxBUF is empty

In Receive mode:
1 = SSPxBUF is full (does not include the $\overline{\text{ACK}}$ and Stop bits)
0 = SSPxBUF is empty (does not include the $\overline{\text{ACK}}$ and Stop bits)

Note 1: This bit is cleared on Reset and when SSPEN is cleared.

2: This bit holds the R/$\overline{W}$ bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not $\overline{\text{ACK}}$ bit.

3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

REGISTER 26-9: SSPxCON3: MSSPx CONTROL REGISTER 3 (I²C MASTER MODE)

R/HS/HC-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	HS/HC = Bit is set/cleared by hardware
x = Bit is unknown	'0' = Bit is cleared	

bit 7 **ACKTIM:** Acknowledge Time Status bit
Unused in Master mode.

bit 6 **PCIE:** Stop Condition Interrupt Enable bit(1)
1 = Enable interrupt on detection of Stop condition
0 = Stop detection interrupts are disabled

bit 5 **SCIE:** Start Condition Interrupt Enable bit(1)
1 = Enable interrupt on detection of Start or Restart conditions
0 = Start detection interrupts are disabled

bit 4 **BOEN:** Buffer Overwrite Enable bit
1 = SSPxBUF is updated every time a new data byte is available, ignoring the SSPOV effect on updating the buffer
0 = SSPxBUF is only updated when SSPOV is clear

bit 3 **SDAHT:** SDA Hold Time Selection bit
1 = Minimum of 300ns hold time on SDA after the falling edge of SCL
0 = Minimum of 100ns hold time on SDA after the falling edge of SCL

bit 2 **SBCDE:** Slave Mode Bus Collision Detect Enable bit
Unused in Master mode.

bit 1 **AHEN:** Address Hold Enable bit
Unused in Master mode.

bit 0 **DHEN:** Data Hold Enable bit
Unused in Master mode.

Note 1: This bit has no effect when SSPM<3:0> = 1111 or 1110.In these Slave modes the START and STOP condition interrupts are always enabled.

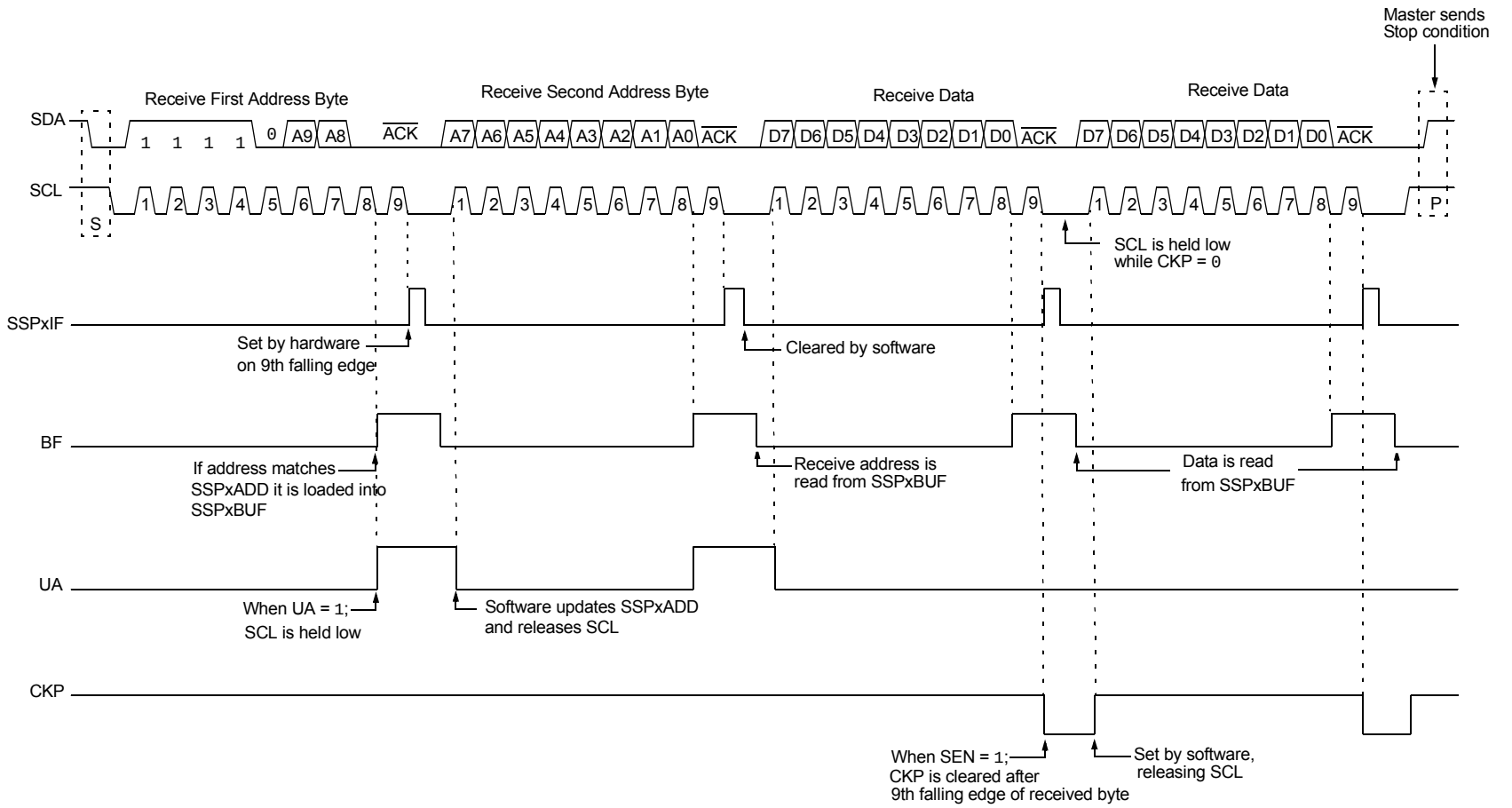
REGISTER 26-10: SSPxBUF: MSSP DATA BUFFER REGISTER (I²C MASTER MODE)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
BUF<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **BUF<7:0>:** MSSP Buffer bits

FIGURE 26-20: I²C SLAVE, 10-BIT ADDRESS, RECEPTION (SEN = 1, AHEN = 0, DHEN = 0)



26.10.13.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

a) A low level is sampled on SDA when SCL goes from low level to high level (Case 1).

b) SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1' (Case 2).

When the user releases SDA and the pin is allowed to float high, the BRG is loaded with SSPxADD and counts down to zero. The SCL pin is then deasserted and when sampled high, the SDA pin is sampled.

If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', Figure 26-36). If SDA is sampled high, the BRG is reloaded and begins counting. If SDA goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDA at exactly the same time.

If SCL goes from high-to-low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition, see Figure 26-37.

If, at the end of the BRG time out, both SCL and SDA are still high, the SDA pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated Start condition is complete.

FIGURE 26-36: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

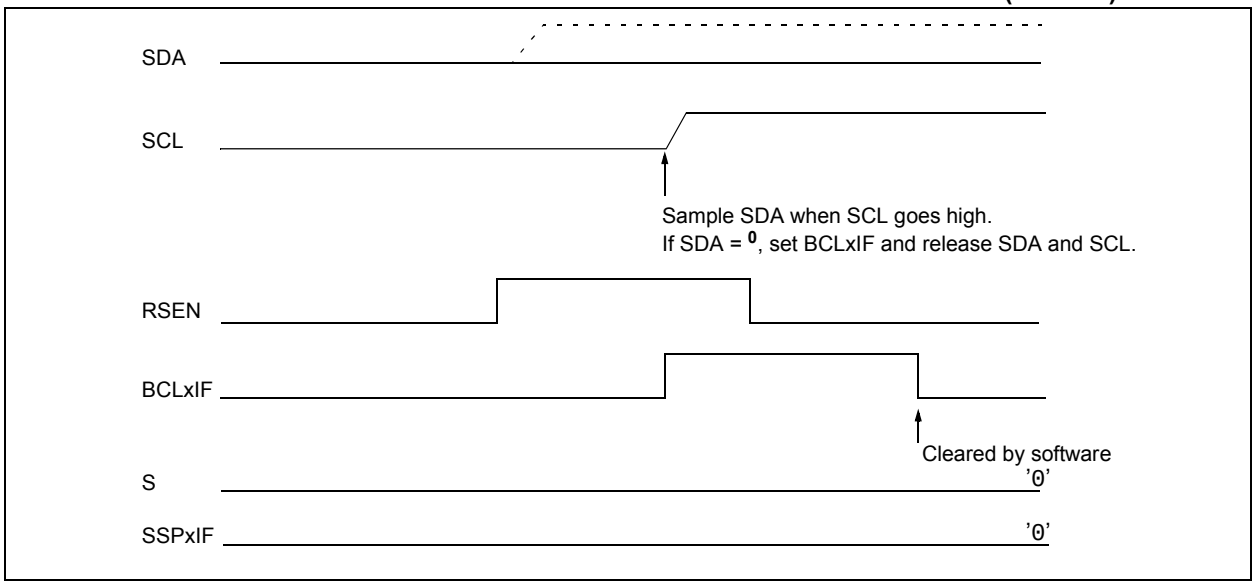
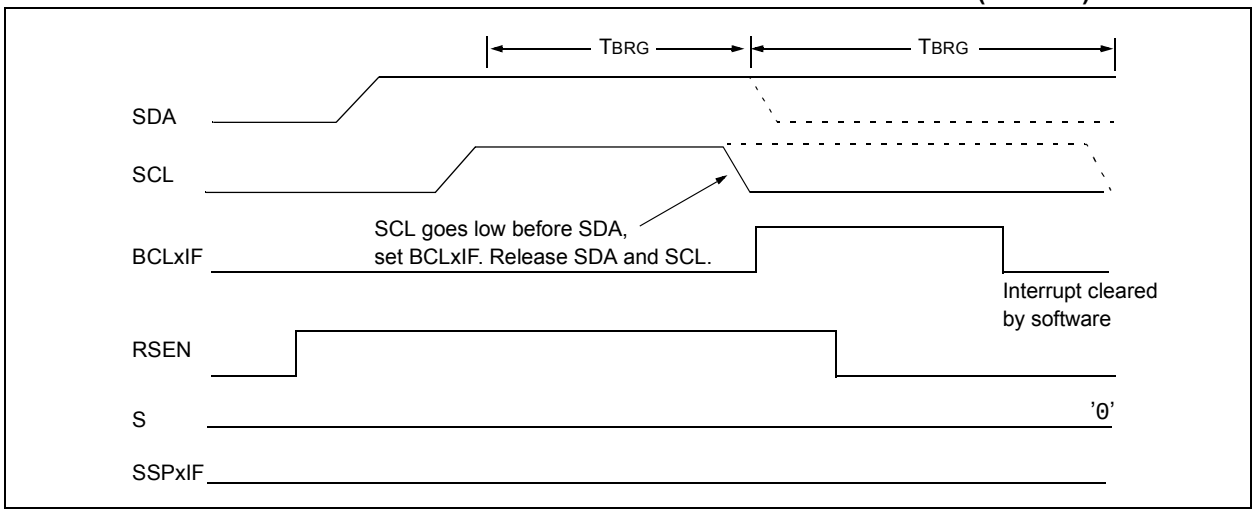


FIGURE 26-37: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



30.6 Register Definitions: DAC Control

Long bit name prefixes for the DAC peripheral is shown in Table 30-1. Refer to **Section 1.4.2.2 "Long Bit Names"** for more information.

TABLE 30-1:

Peripheral	Bit Name Prefix
DAC	DAC

REGISTER 30-1: DAC1CON0: DAC CONTROL REGISTER

R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0
EN	—	OE1	OE2	PSS<1:0>		—	NSS
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **EN:** DAC Enable bit
1 = DAC is enabled
0 = DAC is disabled

bit 6 **Unimplemented:** Read as '0'

bit 5 **OE1:** DAC Voltage Output Enable bit
1 = DAC voltage level is output on the DAC1OUT1 pin
0 = DAC voltage level is disconnected from the DAC1OUT1 pin

bit 4 **OE2:** DAC Voltage Output Enable bit
1 = DAC voltage level is output on the DAC1OUT2 pin
0 = DAC voltage level is disconnected from the DAC1OUT2 pin

bit 3-2 **PSS<1:0>:** DAC Positive Source Select bit
11 = Reserved
10 = FVR buffer
01 = V_{REF+}
00 = AV_{DD}

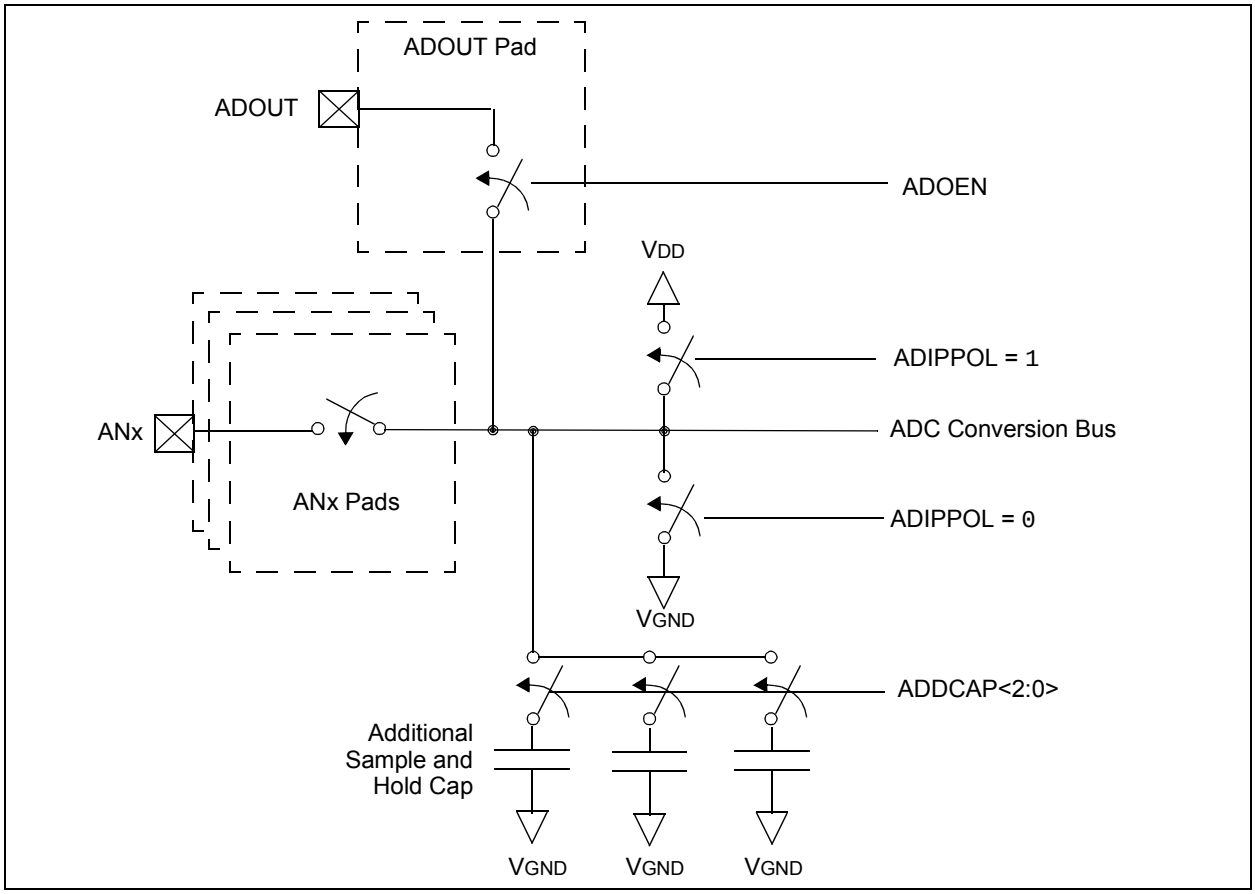
bit 1 **Unimplemented:** Read as '0'

bit 0 **NSS:** DAC Negative Source Select bit
1 = V_{REF-}
0 = AV_{SS}

31.4 Capacitive Voltage Divider (CVD) Features

The ADC module contains several features that allow the user to perform a relative capacitance measurement on any ADC channel using the internal ADC sample and hold capacitance as a reference. This relative capacitance measurement can be used to implement capacitive touch or proximity sensing applications. Figure 31-6 shows the basic block diagram of the CVD portion of the ADC module.

FIGURE 31-6: HARDWARE CAPACITIVE VOLTAGE DIVIDER BLOCK DIAGRAM



REGISTER 31-9: ADPRE: ADC PRECHARGE TIME CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ADPRE<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADPRE<7:0>**: Precharge Time Select bits
11111111 = Precharge time is 255 clocks of the selected ADC clock
11111110 = Precharge time is 254 clocks of the selected ADC clock
•
•
•
00000001 = Precharge time is 1 clock of the selected ADC clock
00000000 = Precharge time is not included in the data conversion cycle

REGISTER 31-10: ADACQ: ADC ACQUISITION TIME CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ADACQ<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADACQ<7:0>**: Acquisition (charge share time) Select bits
11111111 = Acquisition time is 255 clocks of the selected ADC clock
11111110 = Acquisition time is 254 clocks of the selected ADC clock
•
•
•
00000001 = Acquisition time is 1 clock of the selected ADC clock
00000000 = Acquisition time is not included in the data conversion cycle

Note: If ADPRE is not equal to ‘0’, then ADACQ = b’00000000 means Acquisition time is 256 clocks of the selected ADC clock.

32.11 CWG1 Auto-Shutdown Source

The output of the comparator module can be used as an auto-shutdown source for the CWG1 module. When the output of the comparator is active and the corresponding WGASxE is enabled, the CWG operation will be suspended immediately (see **Section 24.10.1.2 "External Input Source"**).

32.12 ADC Auto-Trigger Source

The output of the comparator module can be used to trigger an ADC conversion. When the ADACT register is set to trigger on a comparator output, an ADC conversion will trigger when the Comparator output goes high.

32.13 TMR2/4/6 Reset

The output of the comparator module can be used to reset Timer2. When the TxERS register is appropriately set, the timer will reset when the Comparator output goes high.

32.14 Operation in Sleep Mode

The comparator module can operate during Sleep. The comparator clock source is based on the Timer1 clock source. If the Timer1 clock source is either the system clock (FOSC) or the instruction clock (FOSC/4), Timer1 will not operate during Sleep, and synchronized comparator outputs will not operate.

A comparator interrupt will wake the device from Sleep. The CxIE bits of the PIE2 register must be set to enable comparator interrupts.

SUBLW **Subtract W from literal**

Syntax: SUBLW k

Operands: $0 \le k \le 255$

Operation: $k - (W) \rightarrow W$

Status Affected: N, OV, C, DC, Z

Encoding:

0000	1000	kkkk	kkkk

Description: W is subtracted from the 8-bit literal 'k'. The result is placed in W.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to W

Example 1: `SUBLW 02h`

Before Instruction
W = 01h
C = ?
After Instruction
W = 01h
C = 1 ; result is positive
Z = 0
N = 0

Example 2: `SUBLW 02h`

Before Instruction
W = 02h
C = ?
After Instruction
W = 00h
C = 1 ; result is zero
Z = 1
N = 0

Example 3: `SUBLW 02h`

Before Instruction
W = 03h
C = ?
After Instruction
W = FFh ; (2's complement)
C = 0 ; result is negative
Z = 0
N = 1

SUBWF **Subtract W from f**

Syntax: SUBWF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: $(f) - (W) \rightarrow$ dest

Status Affected: N, OV, C, DC, Z

Encoding:

0101	11da	ffff	ffff

Description: Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 35.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example 1: `SUBWF REG, 1, 0`

Before Instruction
REG = 3
W = 2
C = ?
After Instruction
REG = 1
W = 2
C = 1 ; result is positive
Z = 0
N = 0

Example 2: `SUBWF REG, 0, 0`

Before Instruction
REG = 2
W = 2
C = ?
After Instruction
REG = 2
W = 0
C = 1 ; result is zero
Z = 1
N = 0

Example 3: `SUBWF REG, 1, 0`

Before Instruction
REG = 1
W = 2
C = ?
After Instruction
REG = FFh ;(2's complement)
W = 2
C = 0 ; result is negative
Z = 0
N = 1

ADDWF **ADD W to Indexed (Indexed Literal Offset mode)**

Syntax: ADDWF [k] {,d}

Operands: $0 \le k \le 95$
$d \in [0,1]$

Operation: (W) + ((FSR2) + k) → dest

Status Affected: N, OV, C, DC, Z

Encoding:

0010	01d0	kkkk	kkkk

Description: The contents of W are added to the contents of the register indicated by FSR2, offset by the value 'k'.
If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process Data	Write to destination

Example: ADDWF [OFST], 0

Before Instruction
W = 17h
OFST = 2Ch
FSR2 = 0A00h
Contents of 0A2Ch = 20h
After Instruction
W = 37h
Contents of 0A2Ch = 20h

BSF **Bit Set Indexed (Indexed Literal Offset mode)**

Syntax: BSF [k], b

Operands: $0 \le f \le 95$
$0 \le b \le 7$

Operation: 1 → ((FSR2) + k)<b>

Status Affected: None

Encoding:

1000	bbb0	kkkk	kkkk

Description: Bit 'b' of the register indicated by FSR2, offset by the value 'k', is set.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: BSF [FLAG_OFST], 7

Before Instruction
FLAG_OFST = 0Ah
FSR2 = 0A00h
Contents of 0A0Ah = 55h
After Instruction
Contents of 0A0Ah = D5h

SETF **Set Indexed (Indexed Literal Offset mode)**

Syntax: SETF [k]

Operands: $0 \le k \le 95$

Operation: FFh → ((FSR2) + k)

Status Affected: None

Encoding:

0110	1000	kkkk	kkkk

Description: The contents of the register indicated by FSR2, offset by 'k', are set to FFh.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process Data	Write register

Example: SETF [OFST]

Before Instruction
OFST = 2Ch
FSR2 = 0A00h
Contents of 0A2Ch = 00h
After Instruction
Contents of 0A2Ch = FFh

FIGURE 37-7: CLKOUT AND I/O TIMING

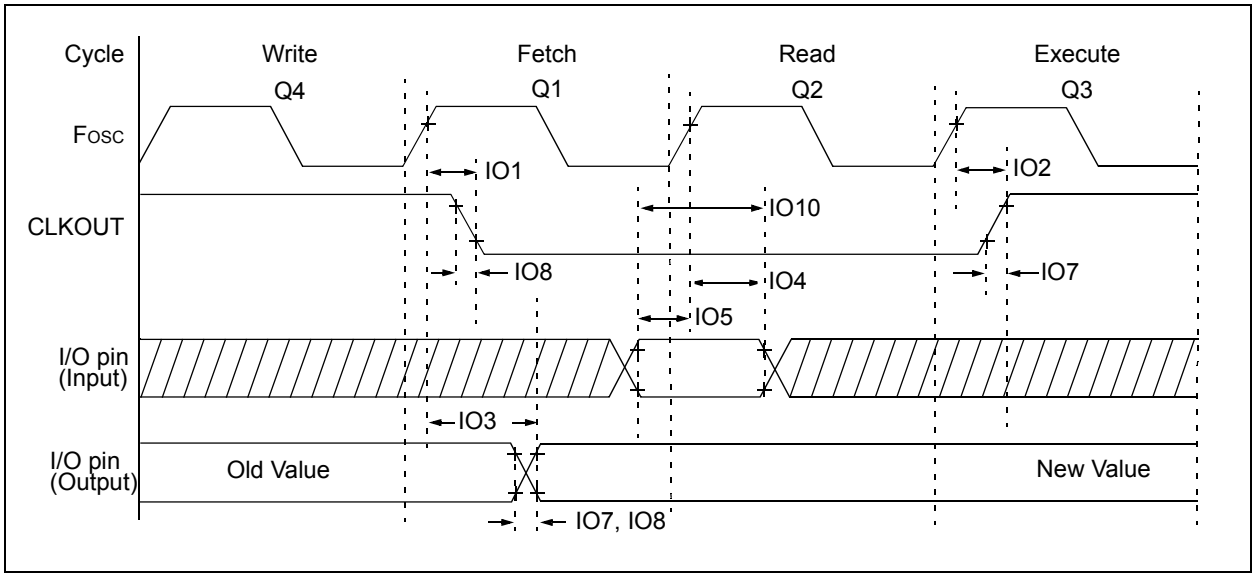


TABLE 37-10: I/O AND CLKOUT TIMING SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
IO1*	$T_{CLKOUTH}$	CLKOUT rising edge delay (rising edge Fosc (Q1 cycle) to falling edge CLKOUT	—	—	70	ns	
IO2*	$T_{CLKOUTL}$	CLKOUT falling edge delay (rising edge Fosc (Q3 cycle) to rising edge CLKOUT	—	—	72	ns	
IO3*	T_{IO_VALID}	Port output valid time (rising edge Fosc (Q1 cycle) to port valid)	—	50	70	ns	
IO4*	T_{IO_SETUP}	Port input setup time (Setup time before rising edge Fosc – Q2 cycle)	20	—	—	ns	
IO5*	T_{IO_HOLD}	Port input hold time (Hold time after rising edge Fosc – Q2 cycle)	50	—	—	ns	
IO6*	T_{IOR_SLREN}	Port I/O rise time, slew rate enabled	—	25	—	ns	V_{DD} = 3.0V
IO7*	T_{IOR_SLRDIS}	Port I/O rise time, slew rate disabled	—	5	—	ns	V_{DD} = 3.0V
IO8*	T_{IOF_SLREN}	Port I/O fall time, slew rate enabled	—	25	—	ns	V_{DD} = 3.0V
IO9*	T_{IOF_SLRDIS}	Port I/O fall time, slew rate disabled	—	5	—	ns	V_{DD} = 3.0V
IO10*	T_{INT}	INT pin high or low time to trigger an interrupt	25	—	—	ns	
IO11*	T_{IOC}	Interrupt-on-Change minimum high or low time to trigger interrupt	25	—	—	ns	

*These parameters are characterized but not tested.